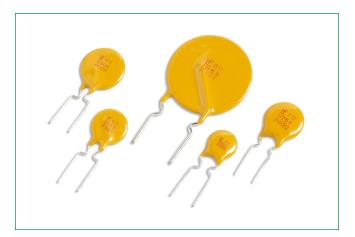
60R Series Radial Leaded





Web Resources



Download ECAD models, order samples, and find technical recources at www.littelfuse.com

Description

The 60R Series radial leaded device is designed to provide overcurrent protection for (≤60V) applications where space is not a concern and resettable protection is preferred.

Features & Benefits

- Cured, flame retardant epoxy polymer insulating material meets UL 94V-0 requirements
- Fast time-to-trip
- RoHS compliant, Lead-Free and Halogen-Free*

Applications

- USB hubs, ports and peripherals
- IEEE1394 ports
- Computers & peripherals
- Motor protection
- General electronics
- Automotive applications
- Industrial controls
- Transformers

Agency Approvals

Agency	Agency File Number
71 °	E74889
Δ τΰν	R72161785

Electrical Characteristics

Part Number	I hold	I _{trin}	V max	l _{max}	P _d	Maximum '	Time To Trip	Resis	tance	Agency A	Approvals
Part Number	(Å)	I trip (A)	(Vdc)	(Ä)	typ. (W)	Current (A)	Time (Sec.)	R _{min} (Ω)	R _{1max} (Ω)	71 °	△ TÜV
60R010X	0.10	0.20	60	40	0.38	0.50	4.00	2.500	7.500	X	Χ
60R017X	0.17	0.34	60	40	0.48	0.85	3.00	3.300	8.000	X	Χ
60R020X	0.20	0.40	60	40	0.41	1.00	2.20	1.830	4.400	X	X
60R025X	0.25	0.50	60	40	0.45	1.25	2.50	1.250	3.000	X	Χ
60R030X	0.30	0.60	60	40	0.49	1.50	3.00	0.880	2.100	X	Χ
60R040X	0.40	0.80	60	40	0.56	2.00	3.80	0.550	1.290	X	Χ
60R050X	0.50	1.00	60	40	0.77	2.50	4.00	0.500	1.170	X	X
60R065X	0.65	1.30	60	40	0.88	3.25	5.30	0.310	0.720	X	Χ
60R075X	0.75	1.50	60	40	0.92	3.75	6.30	0.250	0.600	X	X
60R090X	0.90	1.80	60	40	0.99	4.50	7.20	0.200	0.470	X	X
60R110X	1.10	2.20	60	40	1.50	5.50	8.20	0.150	0.380	Χ	Χ
60R135X	1.35	2.70	60	40	1.70	6.75	9.60	0.120	0.300	X	Χ
60R160X	1.60	3.20	60	40	1.90	8.00	11.40	0.090	0.220	Χ	Χ
60R185X	1.85	3.70	60	40	2.10	9.25	12.60	0.080	0.190	X	X
60R250X	2.50	5.00	60	40	2.50	12.50	15.60	0.050	0.130	X	Χ
60R300X	3.00	6.00	60	40	2.80	15.00	19.80	0.040	0.100	X	Χ
60R375X	3.75	7.50	60	40	3.20	18.75	24.00	0.030	0.080	X	Χ

I $_{\mathrm{hold}}$ = Hold current: maximum current device will pass without tripping in 20°C still air.



I $_{\mbox{\scriptsize trip}}$ = Trip current: minimum current at which the device will trip in 20°C still air.

 V_{\max} = Maximum voltage device can withstand without damage at rated current (I max)

I $_{\max}$ = Maximum fault current device can withstand without damage at rated voltage (V_{\max})

 $[\]rm P_{\rm d}$ = Power dissipated from device when in the tripped state at 20°C still air.

 R_{\min} = Minimum resistance of device in initial (un-soldered) state.

 R_{typ} = Typical resistance of device in initial (un-soldered) state.

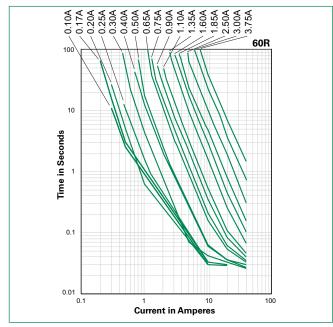
R $_{\rm 1max}$ = Maximum resistance of device at 20°C measured one hour after tripping or reflow soldering of 260°C for 20 sec.

Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.

Temperature Rerating

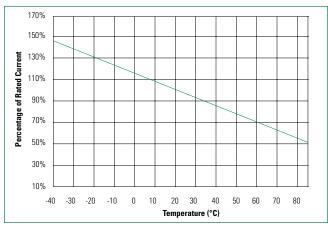
			Ambient	Operation Ter	nperature					
	-40°C	-20°C	0°C	20°C	40°C	50°C	60°C	70°C	85°C	
Part Number		Hold Current (A)								
60R010X	0.16	0.14	0.12	0.10	0.08	0.07	0.06	0.05	0.04	
60R017X	0.26	0.23	0.20	0.17	0.14	0.12	0.11	0.09	0.07	
60R020X	0.31	0.27	0.24	0.20	0.16	0.14	0.13	0.11	0.08	
60R025X	0.39	0.34	0.30	0.25	0.20	0.18	0.16	0.14	0.10	
60R030X	0.47	0.41	0.36	0.30	0.24	0.22	0.19	0.16	0.12	
60R040X	0.62	0.54	0.48	0.40	0.32	0.29	0.25	0.22	0.16	
60R050X	0.78	0.68	0.60	0.50	0.41	0.36	0.32	0.27	0.20	
60R065X	1.01	0.88	0.77	0.65	0.53	0.47	0.41	0.35	0.26	
60R075X	1.16	1.02	0.89	0.75	0.61	0.54	0.47	0.41	0.30	
60R090X	1.40	1.22	1.07	0.90	0.73	0.65	0.57	0.49	0.36	
60R110X	1.71	1.50	1.31	1.10	0.89	0.79	0.69	0.59	0.44	
60R135X	2.09	1.84	1.61	1.35	1.09	0.97	0.85	0.73	0.54	
60R160X	2.48	2.18	1.90	1.60	1.30	1.15	1.01	0.86	0.64	
60R185X	2.87	2.52	2.20	1.85	1.50	1.33	1.17	1.00	0.74	
60R250X	3.88	3.40	2.98	2.50	2.03	1.80	1.58	1.35	1.00	
60R300X	4.65	4.08	3.57	3.00	2.43	2.16	1.89	1.62	1.20	
60R375X	5.81	5.10	4.46	3.75	3.04	2.70	2.36	2.03	1.50	

Average Time Current Curves



The average time current curves and Temperature Rerating curve performance is affected by a number or variables, and these curves provided as guidance only. Customer must verify the performance in their application.

Temperature Rerating Curve

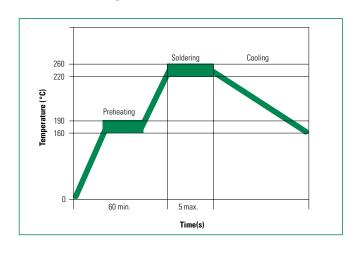


Note: Typical Temperature rerating curve, refer to table for derating dat



Soldering Parameters - Wave Soldering

Pre-Heating Zone	Refer to the condition recommended by the flux manufacturer.					
	Max. ramping rate should not exceed 4°C/Sec.					
	Max. solder temperature should not exceed 260°C					
Soldering Zone	Time within 5°C of actual Max. solder temperature within 3 - 5 seconds					
	Total time from 25°C room to Max. solder temperature within 5 minutes including Pre- Heating time					
	Cooling by natural convection in air.					
Cooling Zone	Max. ramping down rate should not exceed 6°C/Sec.					



Physical Specifications

Lead Material	.2040A: Tin-plated Copper clad steel .50-3.75A: Tin-plated Copper
Soldering Characteristics	Solderability per MIL-STD-202, Method 208
Insulating Material	Cured, flame retardant epoxy polymer meets UL94V-0 requirements.
Device Labeling	Marked with 'LF', voltage, current rating, and date code.

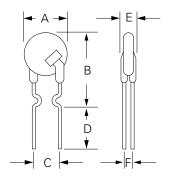
Environmental Specifications

Maximum Device Surface Temperature in Tripped State Passive Aging +85°C, 1000 hours -/+ 5% typical resistance change +85°C, 85% R.H.,1000 hours -/+ 5% typical resistance change +85°C to -40°C 10 times	Operating/Storage Temperature	-40°C to +85°C
Passive Aging -/+ 5% typical resistance change +85°C, 85% R.H.,1000 hours -/+ 5% typical resistance change	maximum 201100 Canado	125°C
-/+ 5% typical resistance change	Passive Aging	
+85°C to -40°C 10 times	Humidity Aging	
30% typical resistance change	Thermal Shock	
Solvent Resistance MIL–STD–202, Method 215	Solvent Resistance	MIL-STD-202, Method 215
Moisture Resistance Level Level 1, J-STD-020	Moisture Resistance Level	Level 1, J-STD-020

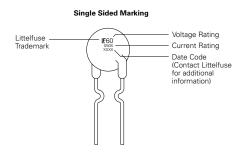


60R SeriesRadial Leaded

Dimensions



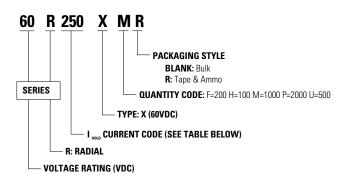
Part Marking System



	Δ		В		С		D		E		F		Physic	al Chara	acteristics
Part Number	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Inches	mm	Lead (dia)	Material
	Max.	Max.	Max.	Max.	Тур.	Тур.	Min.	Min.	Max.	Max.	Тур.	Тур.	Inches	mm	iviateriai
60R010X	0.29	7.4	0.50	12.7	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/CuFe
60R017X	0.29	7.4	0.50	12.7	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/CuFe
60R020X	0.29	7.4	0.46	11.7	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/CuFe
60R025X	0.29	7.4	0.50	12.7	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/CuFe
60R030X	0.29	7.4	0.50	12.7	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/CuFe
60R040X	0.30	7.6	0.53	13.5	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/CuFe
60R050X	0.31	7.9	0.54	13.7	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/Cu
60R065X	0.37	9.4	0.57	14.5	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/Cu
60R075X	0.40	10.2	0.59	15	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/Cu
60R090X	0.44	11.2	0.62	15.8	0.20	5.1	0.30	7.6	0.12	3.1	0.047	1.2	0.02	0.51	Sn/Cu
60R110X	0.51	13	0.72	18.2	0.20	5.1	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
60R135X	0.53	13.58	0.78	19.8	0.20	5.1	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
60R160X	0.60	15.36	0.85	21.6	0.20	5.1	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
60R185X	0.66	16.76	0.91	23	0.20	5.1	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
60R250X	0.78	19.93	1.03	26.2	0.40	10.2	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
60R300X	0.91	23.11	1.15	29.3	0.40	10.2	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu
60R375X	1.04	26.3	1.22	31.1	0.40	10.2	0.30	7.6	0.12	3.1	0.055	1.4	0.03	0.81	Sn/Cu



Part Ordering Number System



Packaging

Part Number	Ordering Number	I _{hold} (A)	I hold Code	Packaging Option	Quantity	Quantity & Packaging Codes
60R010X	60R010XU	0.10	010	Bulk	500	U
OUNUIUX	60R010XPR	0.10	010	Tape and Ammo	2000	PR
60R017X	60R017XU	0.20	020	Bulk	500	U
6UhUI/X	60R017XPR	0.20	020	Tape and Ammo	2000	PR
60R020X	60R020XU	0.20	020	Bulk	500	U
υπυΖυλ	60R020XPR	0.20	020	Tape and Ammo	2000	PR
60R025X	60R025XU	0.25	025	Bulk	500	U
0000237	60R025XPR	0.25	025	Tape and Ammo	2000	PR
60R030X	60R030XU	0.30	030	Bulk	500	U
0000307	60R030XPR	0.30	030	Tape and Ammo	2000	PR
60R040X	60R040XU	0.40	040	Bulk	500	U
0000407	60R040XPR	0.40	040	Tape and Ammo	2000	PR
60R050X	60R050XU	0.50	050	Bulk	500	U
VOCOUDOX	60R050XPR	0.50	050	Tape and Ammo	2000	PR
60R065X	60R065XU	0.65	065	Bulk	500	U
OUNUOSA	60R065XPR	0.00	000	Tape and Ammo	2000	PR
60R075X	60R075XU	0.75	075	Bulk	500	U
0000737	60R075XPR	0.75	075	Tape and Ammo	2000	PR
60R090X	60R090XU	0.90	090	Bulk	500	U
6000907	60R090XPR	0.90	090	Tape and Ammo	2000	PR
60R110X	60R110XU	1.10	110	Bulk	500	U
OUNTIUX	60R110XMR	1.10	110	Tape and Ammo	1000	MR
60R135X	60R135XF	1.35	135	Bulk	200	F
0001338	60R135XMR	1.35	135	Tape and Ammo	1000	MR
60R160X	60R160XF	1.60	160	Bulk	200	F
OUNTOUX	60R160XMR	1.00	100	Tape and Ammo	1000	MR
60R185X	60R185XF	1.85	185	Bulk	200	F
Λασι πυυ	60R185XMR	1.85	100	Tape and Ammo	1000	MR
60R250X	60R250XF	2.50	250	Bulk	200	F
UUNZUUA	60R250XMR	2.00	200	Tape and Ammo	1000	MR
60R300X	60R300XF	3.00	300	Bulk	200	F
60R375X	60R375XH	3.75	375	Bulk	100	Н



Tape and Ammo Specifications

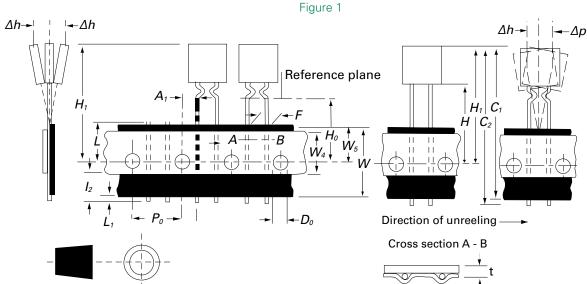
Devices taped using EIA468-B/IE286-2 standards. See table below and Figure 1 for details.

			Dimensions			
Dimension	EIA Mark	IEC Mark	Dim. (mm)	Tol. (mm)		
Carrier tape width	W	W	18	-0.5 / +1.0		
Hold down tape width	W_4	W _o	11	min.		
Top distance between tape edges	W ₆	W_2	3	max.		
Sprocket hole position	W_5	W ₁	9	-0.5 / +0.75		
Sprocket hole diameter*	D_{o}	D _o	4	-0.32 / +0.2		
Abscissa to plane(straight lead)	Н	Н	18.5	-/+ 3.0		
Abscissa to plane(kinked lead)	H _o	H _o	16	-/+ 0.5		
Abscissa to top 60R010-60R090	H ₁	H ₁	32.2	max.		
Abscissa to top 60R110-60R300	H ₁	-	47.5	max.		
Overall width without lead protrusion:60R010-60R090	C ₁	-	42.5	max.		
Overall width without lead protrusion:60R110-60R300	-	-	57	-		
Overall width with lead protrusion:60R010-60R090	C2	-	43.2	max.		
Overall width with lead protrusion:60R110-60R300	-	-	58	-		
Lead protrusion	L ₁	I ₁	1.0	max.		
Protrusion of cut out	L	L	11	max.		
Protrusion beyond hold-down tape			Not specified	-		
Sprocket hole pitch:60R010-60R090	P_0	P ₀	12.7	-/+ 0.3		
Sprocket hole pitch:60R110-60R300	P_0	P ₀	25.4	-/+ 0.5		
Pitch tolerance	-	-	20 consecutive.	-/+ 1		
Device pitch:60R010-60R090	-	-	12.7	-		
Device pitch:60R110-60R300	-	-	25.4	-		
Tape thickness	t	t	0.9	max.		
Tape thickness with splice	t ₁	-	2.0	max.		
Splice sprocket hole alignment	-	-	0	-/+ 0.3		
Body lateral deviation	Δh	Δh	0	-/+ 1.0		
Body tape plane deviation	Δρ	Δρ	0	-/+ 1.3		
Ordinate to adjacent component lead*:60R010-	P ₁	P ₁	3.81	-/+ 0.7		
60R090 Ordinate to adjacent component lead*:60R110- 60R300	-	-	7.62	-/+ 0.7		
Lead spacing:60R010-60R185	F	F	5.08	-/+ 0.8		
Lead spacing:60R250-60R300	F	F	10.18	-/+ 0.8		

^{*}Differs from EIA Specification



Tape and Ammo Diagram



Warning

- Users shall independently assess the suitability of these devices for each of their applications
- Operation of these devices beyond the stated maximum ratings could result in damage to the devices and lead to electrical arcing and/or fire
 These devices are intended to protect against the effects of temporary over-current or over-temperature conditions and are not intended to perform as protective devices where such conditions are expected to be repetitive or prolonged in duration
- Exposure to silicon-based oils, solvents, electrolytes, acids, and similar materials can adversely affect the performance of these PPTC devices
- These devices undergo thermal expansion under fault conditions, and thus shall be provided with adequate space and be protected against mechanical stresses
 Circuits with inductance may generate a voltage (L di/dt) above the rated voltage of the PPTC device.

